

N-Channel Silicon Carbide MOSFET

Rev.02 - 17 May 2023

**Product data sheet** 

#### **1. General description**

Silicon Carbide MOSFET in a TO247-4L plastic package, designed for high frequency, high efficiency systems.

### 2. Features and benefits

- Separate driver source pin
- Low on-resistance
- Fast switching speed
- OV turn-off gate voltage for simple gate drive
- 100% UIS Tested
- Easy to parallel
- Controllable dV/dt for optimized EMI
- Reduced cooling requirements
- RoHS compliant

#### 3. Applications

- Switch Mode Power Supplies
- UPS
- Solar string inverter and solar optimizer
- EV Charger
- Motor Drives

#### 4. Quick reference data

	lick reference data						
Symbol	Parameter	Conditions	Notes	Values		Unit	
Absolute	maximum rating						
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		1200		V	
I <sub>D</sub>	drain current	V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 25 °C			73		А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C		405		W	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$R_{DS(on)}$	drain-source on-state resistance	V <sub>GS</sub> = 15 V; I <sub>D</sub> = 33 A; T <sub>j</sub> = 25 °C		-	40	55	mΩ
Dynamic	characteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_D = 33 \text{ A}; V_{DS} = 800 \text{ V}; V_{GS} = -4 \text{ V}/18 \text{ V};$		-	116	-	nC
Q <sub>GD</sub>	gate-drain charge	T <sub>j</sub> = 25 °C		-	19	-	nC
Source-d	rain diode	·					_
Q <sub>r</sub>	recovered charge	I <sub>SD</sub> = 33 A; di/dt = 500 A/μs; V <sub>DS</sub> = 400 V; T <sub>i</sub> = 25 °C		-	174	-	nC



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### 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain		D
2	S	source		
3	SS	source sense		
4	G	gate		sym301 S
mb	D	mounting base; connected to drain		

# 6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC2M40120R	TO247-4L	WNSC2M40120R6Q	Tube	30	TO247N-4L	17-Dec-2021		

# 7. Marking

Table 4. Marking codes	
Type number	Marking codes
WNSC2M40120R	WNSC2M 40120R

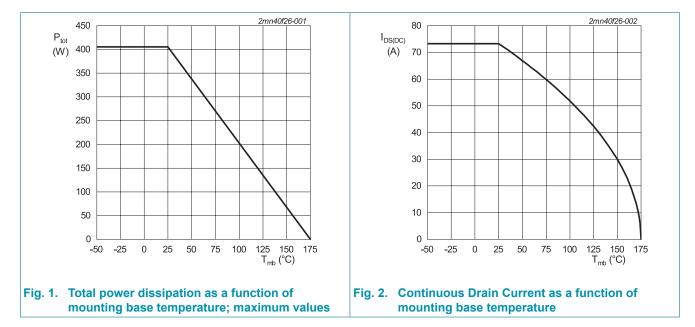
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# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		1200	V
$V_{\text{GS,max}}$	gate-source voltage			-12 to 22	V
$V_{\text{GS,op}}$	gate-source voltage			-4 to 18	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C		405	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 25 °C		73	А
		V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 100 °C		52	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		100	А
E <sub>as</sub>	single pulse drain-to- source avalanche	$I_{AS} = 24 \text{ A}; \text{ L} = 1 \text{ mH}; \text{ V}_{DD} = 100 \text{ V};$ $T_j = 25 \text{ °C}$		288	mJ
T <sub>stg</sub>	storage temperature			-55 to 175	°C
T <sub>j</sub>	junction temperature			-55 to 175	°C
T <sub>sld(M)</sub>	peak soldering temperature			260	°C



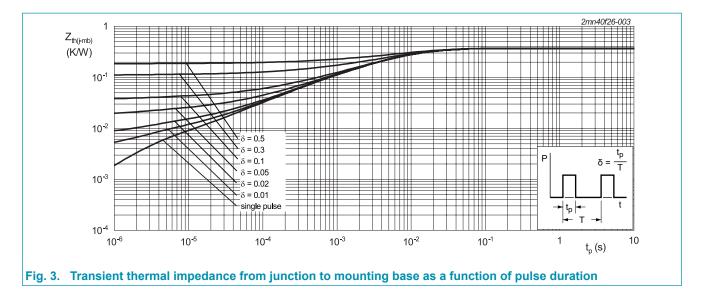
## 9. Thermal & Mechanical characteristics

#### Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base			-	-	0.37	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W
$M_{d}$	Mounting torque	M3 or 6 - 32 screw		-	-	0.6	Nm

Note: It is recommended that a metal washer is inserted between screw head and mounting tab. Do not use self-tapping screws.

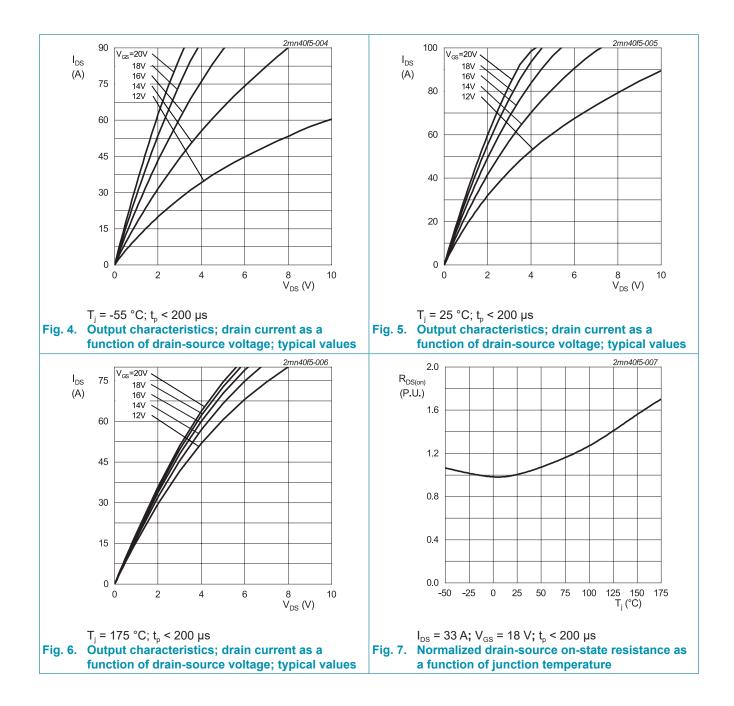
Device is ESD sensitive. Handling precautions are recommanded.

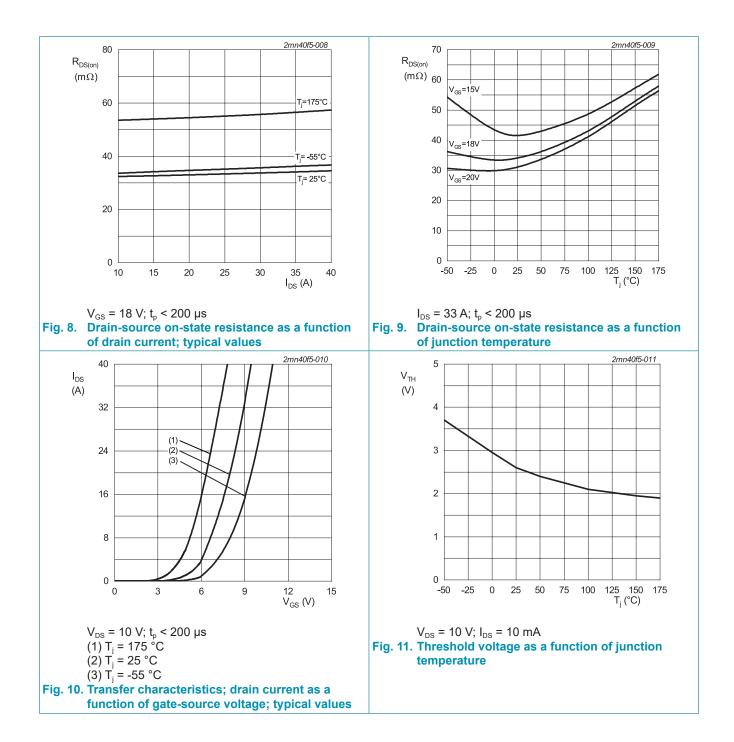


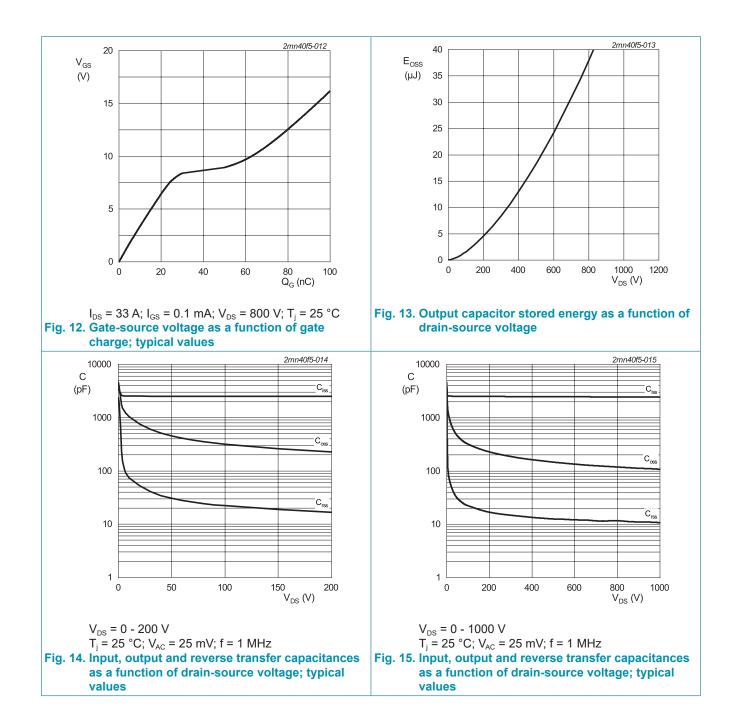
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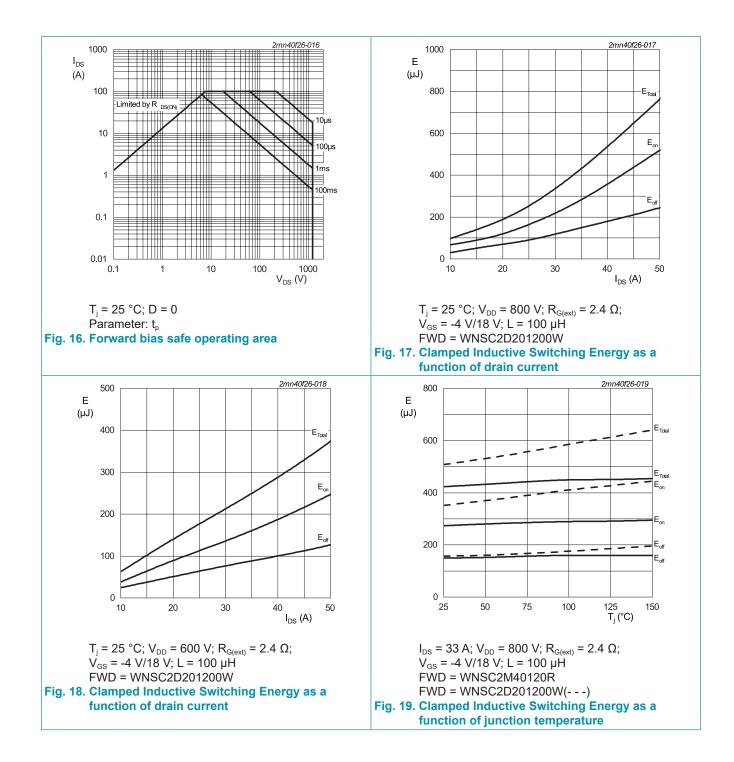
### **10. Characteristics**

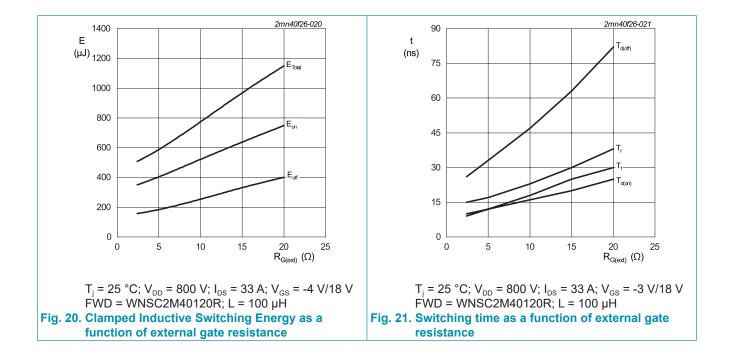
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
	aracteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_{D}$ = 100 µA; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C		1200	-	-	V
V <sub>GS(th)</sub>	gate-source threshold	I <sub>D</sub> = 10 mA; V <sub>DS</sub> = 10 V; T <sub>j</sub> = 25 °C		1.9	2.6	3.5	V
	voltage	I <sub>D</sub> = 10 mA; V <sub>DS</sub> = 10 V; T <sub>j</sub> = 175 °C		-	1.9	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 1200 V; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C		-	0.2	100	μA
		V <sub>DS</sub> = 1200 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 175 °C		-	2	-	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 22 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C		-	10	100	nA
		V <sub>GS</sub> = -8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	10	100	nA
R <sub>DS(on)</sub>	drain-source on-state	V <sub>GS</sub> = 15 V; I <sub>D</sub> = 33 A; T <sub>j</sub> = 25 °C		-	40	-	mΩ
	resistance	V <sub>GS</sub> = 18 V; I <sub>D</sub> = 33 A; T <sub>j</sub> = 25 °C		-	35	46	mΩ
		V <sub>GS</sub> = 18 V; I <sub>D</sub> = 33 A; T <sub>j</sub> = 175 °C		-	58	-	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C		-	1	-	Ω
<b>g</b> <sub>fs</sub>	transconductance	V <sub>DS</sub> = 20 V; I <sub>D</sub> = 33 A; T <sub>j</sub> = 25 °C		-	24	-	S
Dynamic	characteristics	1					
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 33 A; V <sub>DS</sub> = 800 V; V <sub>GS</sub> = -4 V/18 V;		-	116	-	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C		-	42	-	nC
Q <sub>GD</sub>	gate-drain charge			-	19	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = 1000 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$ $T_j = 25 \text{ °C}$		-	2450	-	pF
C <sub>oss</sub>	output capacitance			-	108	-	pF
C <sub>rss</sub>	reverse transfer capacitance	-		-	11	-	pF
E <sub>oss</sub>	Coss stored energy			-	54	-	μJ
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 800 V; $V_{GS}$ = -3 V/18 V; $R_{G(ext)}$ = 2.4		-	10	-	ns
t <sub>r</sub>	rise time	Ω; I <sub>D</sub> = 33 A; L = 100 μH; T <sub>j</sub> = 25 °Ć		-	15	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	26	-	ns
t <sub>f</sub>	fall time			-	9	-	ns
E <sub>on</sub>	turn-on energy (SiC Diode FWD)			-	351	-	μJ
E <sub>off</sub>	turn-off energy (SiC Diode FWD)			-	157	-	μJ
E <sub>on</sub>	turn-on energy (Body Diode FWD)			-	273	-	μJ
E <sub>off</sub>	turn-off energy (Body Diode FWD)			-	150	-	μJ
Source-d	rain diode						
$V_{SD}$	source-drain voltage	$V_{GS}$ = -4 V; I <sub>F</sub> = 17.5 A; T <sub>j</sub> = 25 °C		-	4.8	-	V
		V <sub>GS</sub> = -4 V; I <sub>F</sub> = 17.5 A; T <sub>j</sub> = 175 °C		-	4.2	-	V
t <sub>rr</sub>	reverse recovery time	$I_{sD} = 33 \text{ A}; \text{ di/dt} = 500 \text{ A/}\mu\text{s}; \text{ V}_{DS} = 400 \text{ V};$		-	52	-	ns
Q <sub>r</sub>	recovered charge	T <sub>j</sub> = 25 °C		-	174	-	nC
I <sub>rrm</sub>	reverse recovery current			-	6.8	-	Α





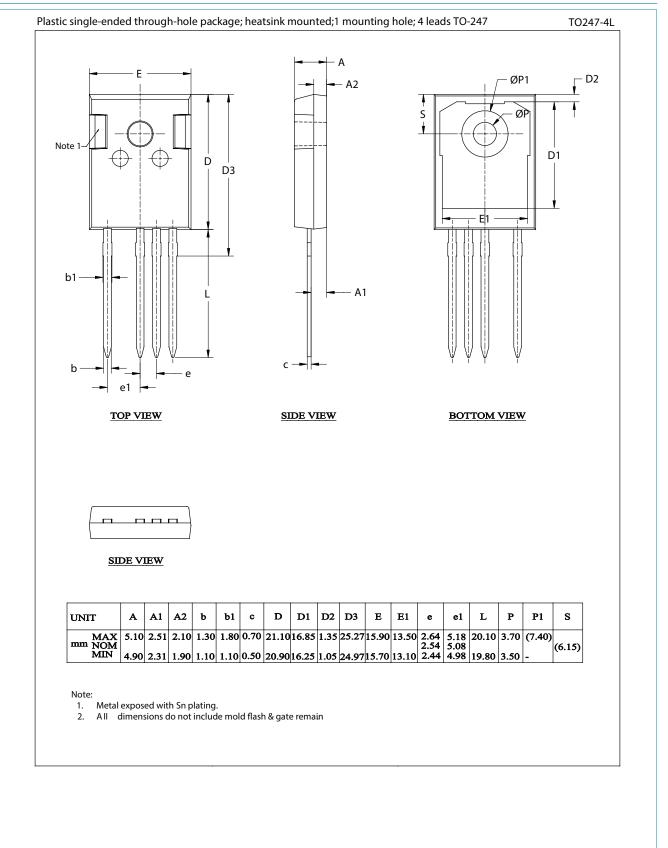






#### WNSC2M40120R N-Channel Silicon Carbide MOSFET

#### 11. Package outline



#### **N-Channel Silicon Carbide MOSFET**

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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